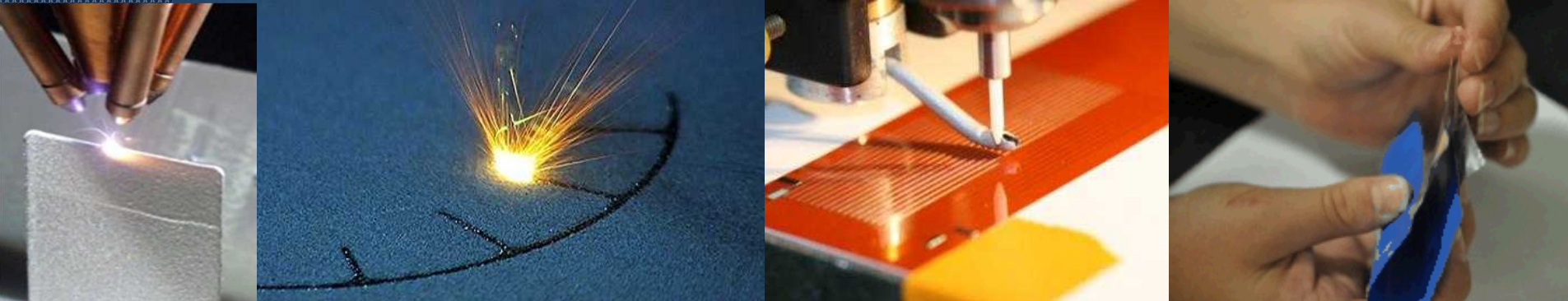


*Exceptional service in the national interest*



# *Additive Manufacturing at Sandia*

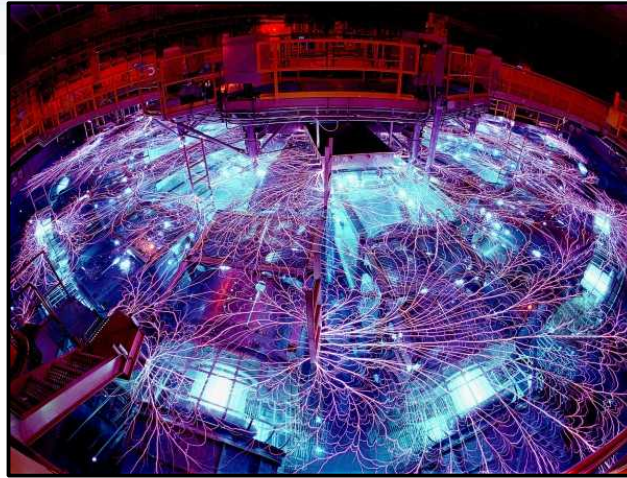
Mark F. Smith

Materials Science & Engineering Center

# *Sandia is a National Security Science and Engineering Laboratory*



*Weapon Drop Test*



*Energy R&D*



*Threat Test*

- Historical mission -- non-nuclear components in nuclear weapons and nuclear weapon security
- Today, broader mission in science & engineering for U.S. national security

*“We work on technologies at a scientific lab, but we must emphasize that science is not an end. The end is solving problems for the nation. Science is perhaps the best tool to achieve that end.”*

C. Paul Robinson, SNL President 1995-2005

# Materials Science at Sandia

*Materials Science Objective: Materials R&D conducted at Sandia will enable mission delivery now and in the future and advance the frontiers of science and engineering.*

## Three Major Areas of Materials R&D

- **Materials Engineering Support**
  - Problem solving, program support
  - Application of existing expertise
  - Point solutions
- **Materials & Process Advanced Development**
  - Advanced & exploratory materials & process development
  - Production process development & technology transfer
  - Understanding the margins
- **Fundamental Materials & Process Science**
  - Develop/integrate theoretical insights, computational simulation tools, and experiments to provide foundational, predictive understanding
  - Develop innovative new materials and process technologies
  - Created advanced materials analysis & process diagnostics tools



Center for Integrated Nano Technologies

Adv. Materials & Processes Lab

Ion Beam Lab



Advanced Materials Lab

Processing & Environmental Tech. Lab

Integrated Materials Research Lab

Thermal Spray Research Lab



# 30+ Years of AM Technology Development and Commercialization

## FastCast \*

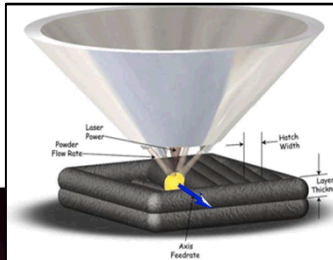
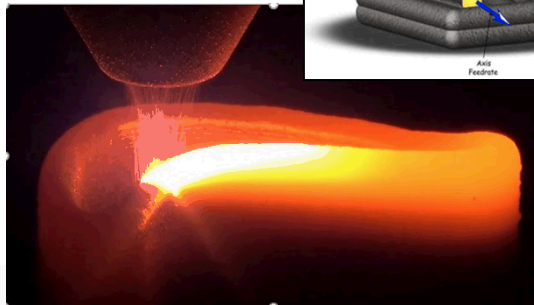
Development Housing



## Laser Engineered Net Shaping \*

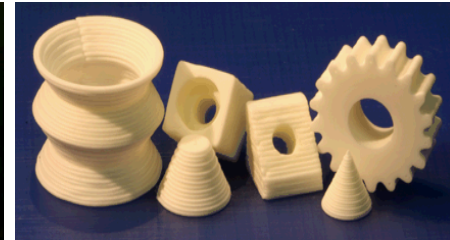
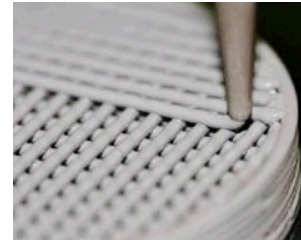
LENS®

LENS Blade



## RoboCast \*

Ceramic Parts

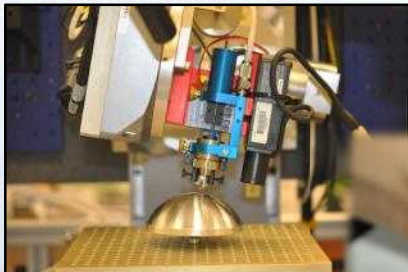


Energetic  
Materials



## Direct Write

Conformal Electronics

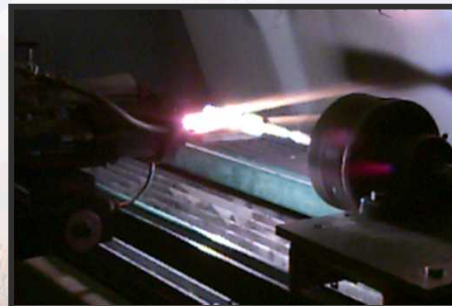


Printed Battery



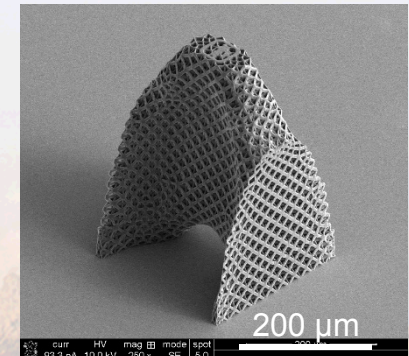
## Spray Forming

Rocket Nozzle



## Micro-Nano Scale AM

Lattice Structure



\* = Licensed/Commercialized Sandia AM technologies  
Underline = Current Capability/Activity



Sandia National Laboratories



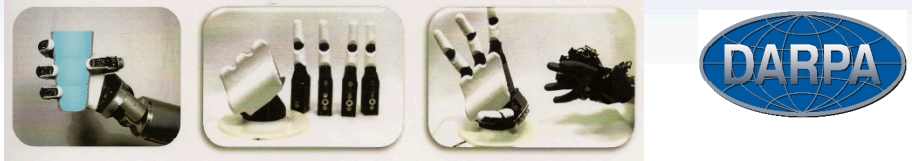
# Example Applications



# Sandia Hand - AM Enabled Innovative Design and Cost Reduction

(~50% of hand built with AM)

- Developed for bomb disablement
- Enabled rapid design iterations
- Cost \$10k vs. ~\$250k
- “Glove” controller
- Current version includes “touch” sensors



Fingers or other tools (e.g., drills) can be quickly magnetically attached in many configurations

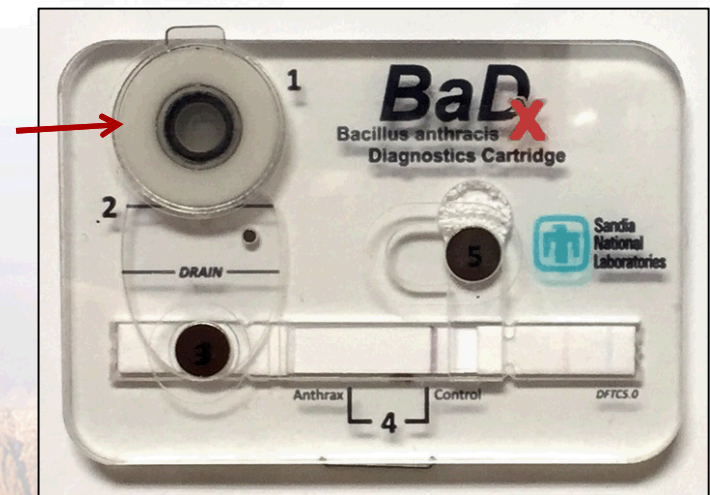


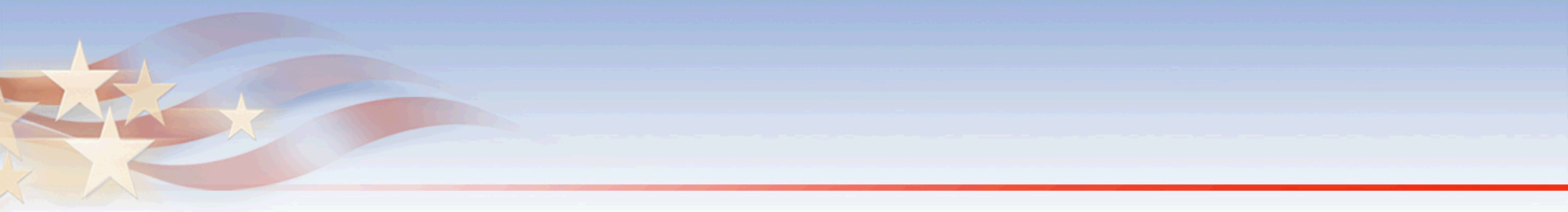
# BaD<sub>x</sub> Anthrax Diagnostics Tool

- Microfluidic platform for bacterial detection
- Self-contained, credit card-sized “Laboratory in a Pocket”
- 3D printed cap
  - Specialized geometry
  - Low cost, quick turnaround



3D Printed  
Cap/Seal





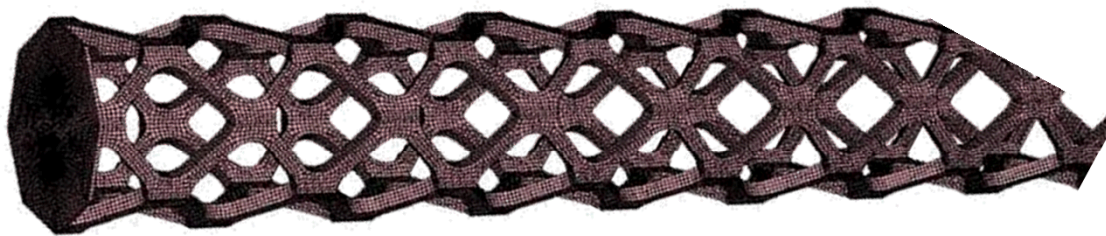
# Design/Analysis Tools



# Analysis-Driven Design Optimization

We combined Topological Optimization (TO) with eXtended Finite Element Modeling (X-FEM) & LENS® to optimize selected properties, e.g., strength/weight ratio

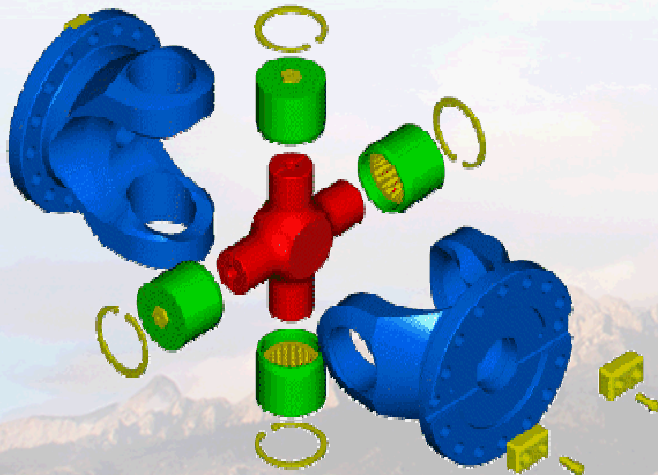
*“Titanium Cholla” LDRD -- Minimum Weight, Maximum Strength, Rapidly Manufactured!*



*With AM it is faster and cheaper to build this optimized shaft than a solid shaft!*

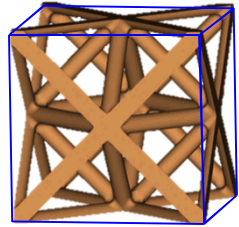


*Core of a dead Cholla cactus (optimized designs often resemble natural structures -- bio-mimicry)*

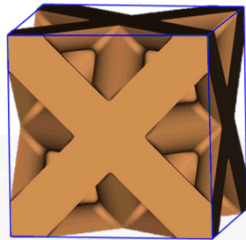
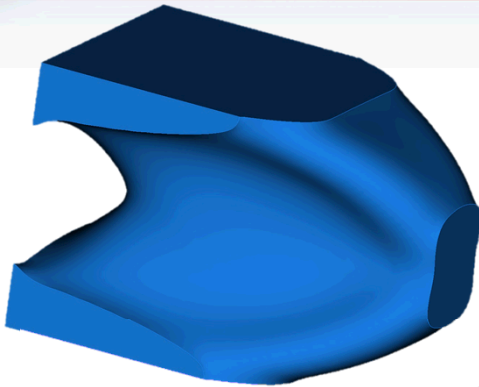


*“Loxosphere” Universal Joint printed as a single integrated assembly –fewer parts, no assembly, no frictional wear!*

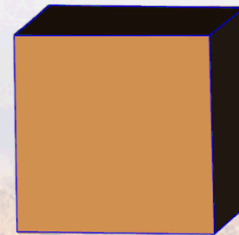
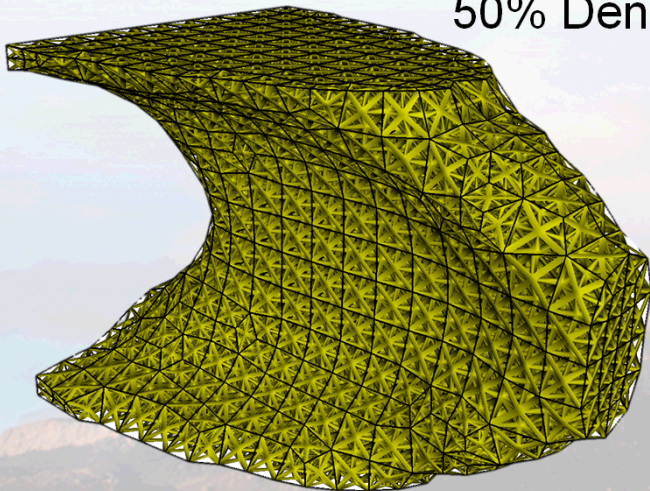
# AM Lattice Structures Optimize Stiffness vs. Weight



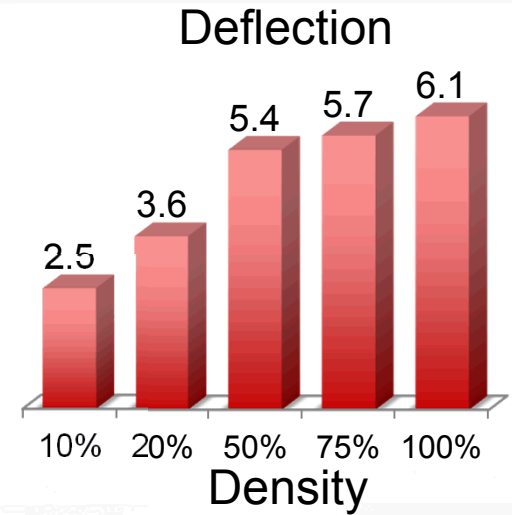
10% Dense



50% Dense



100% Dense





# Materials Assurance

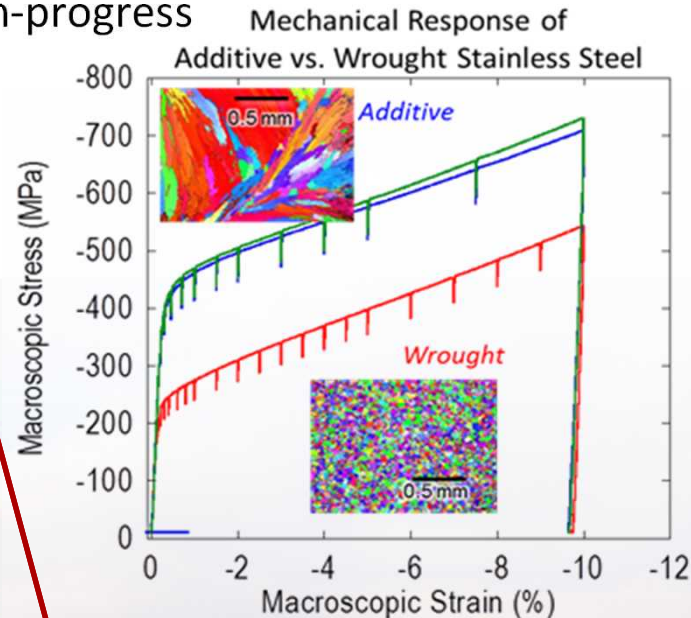
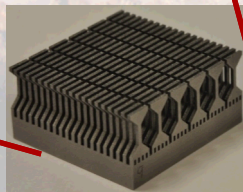
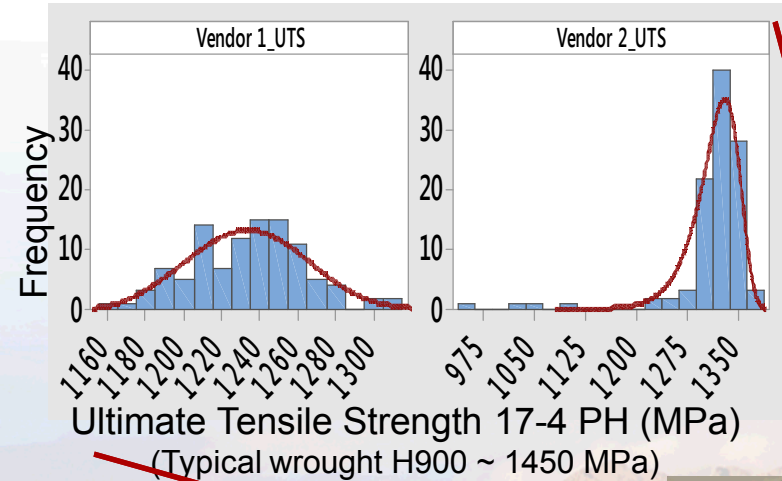


# Residual Stress, Materials Properties, and Variability are Important Issues

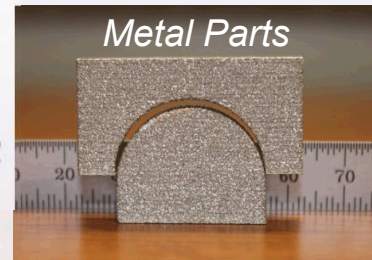
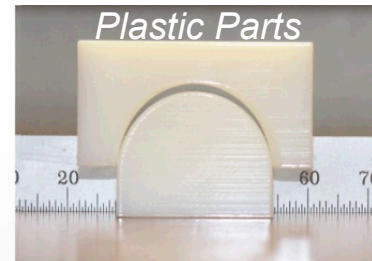
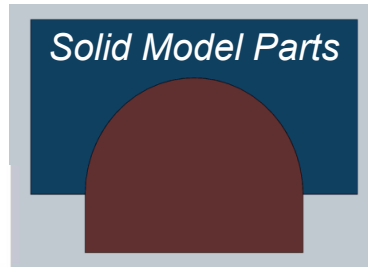
## AM Is Still an Evolving/Emerging Technology

- Residual Stress is a Significant Issue
- Little Available Materials Property/Performance Data (no standards)
- Large Variability in Process and Materials
- Both Experimental & Modeling R&D in-progress

### Large Variability in AM Materials Properties



AM Metals are Unlike Cast or Wrought Metals



Residual Stress Causes Parts to "Move"

# Sandia Metal/Multi-Material AM Process R&D Laboratory

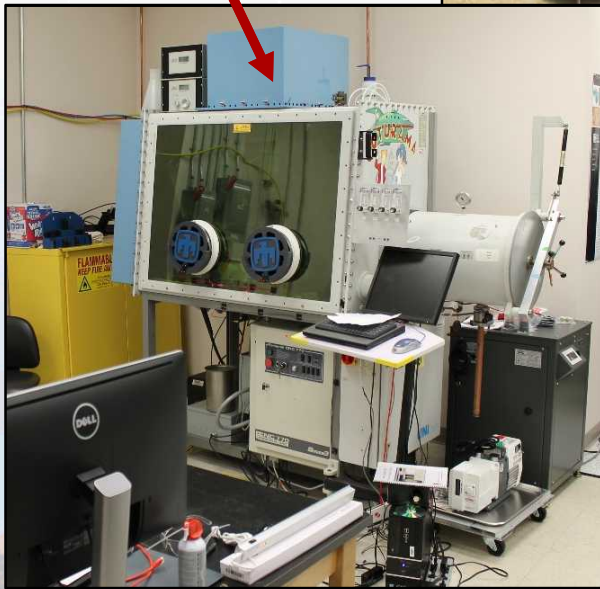
3D Systems ProX 200  
Laser Metal Powder Bed  
Machine



Aspex Explorer SEM-based  
powder particle analyzer

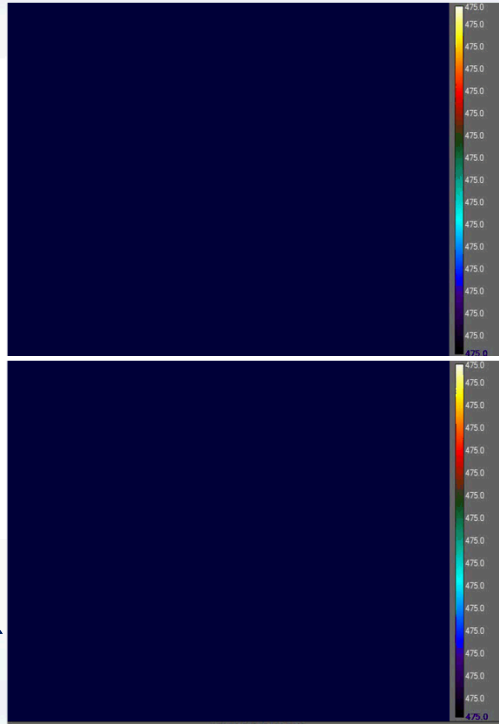
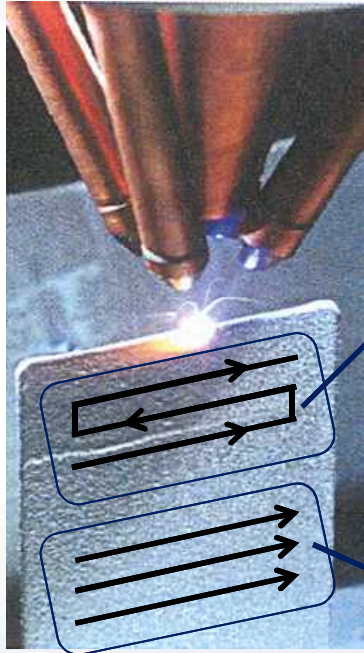


Next Generation Custom  
Built Hybrid LENS™  
System

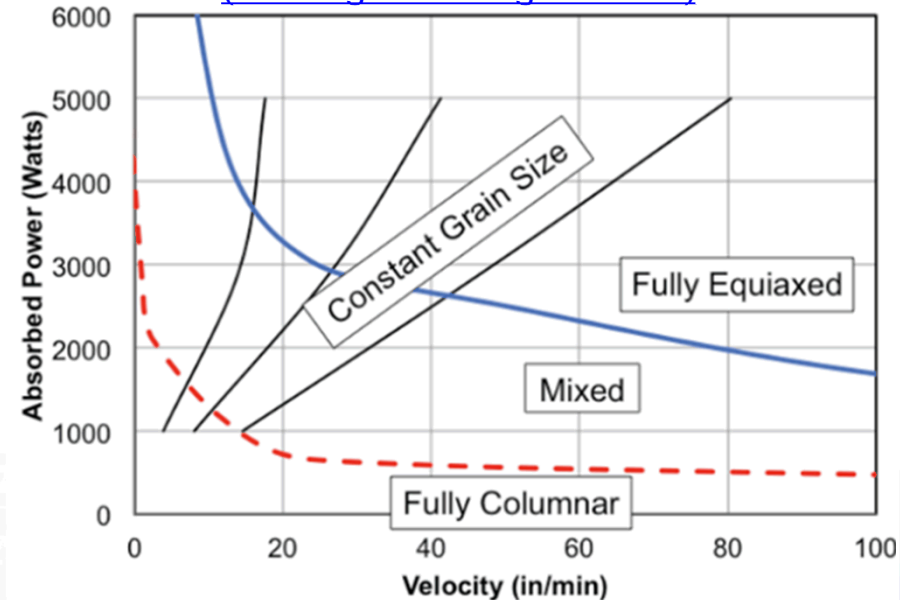


Haas VF2 mill-turn  
machine will be Modified  
for Multi-Material hybrid  
AM, including LENS™

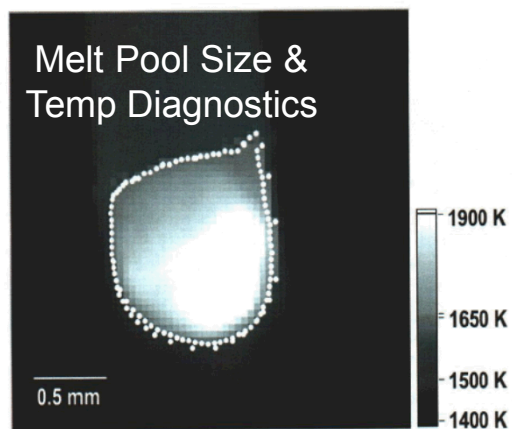
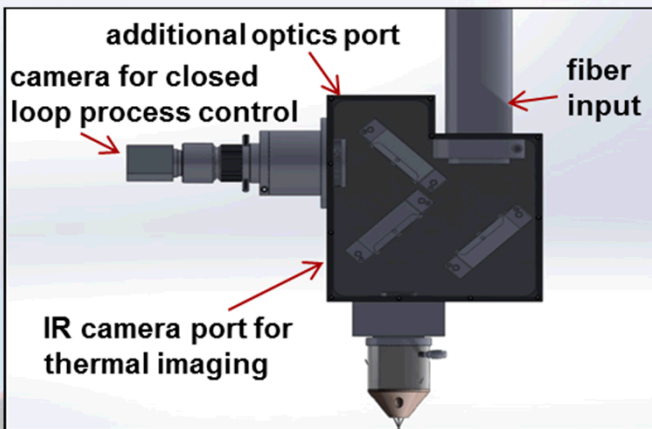
# Working to Understand LENS<sup>TM</sup> Processing-Microstructure Relationships



## Processing-Microstructure Relationships (teaming w Carnegie Mellon)

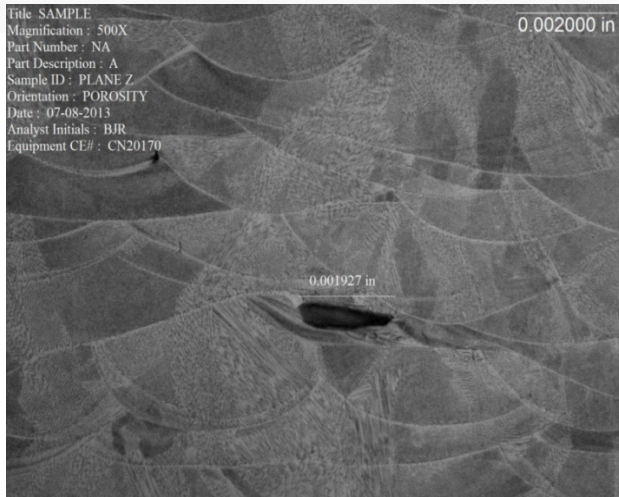


J. Gockel et al. / Additive Manufacturing 1–4 (2014) 119–126



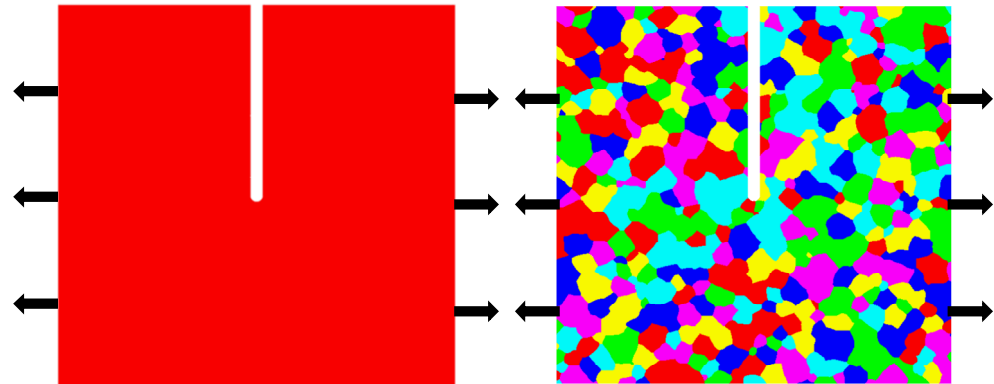
Control melt pool size & temperature to create desired microstructure and reduce variability

# Modeling Microstructure & Behavior

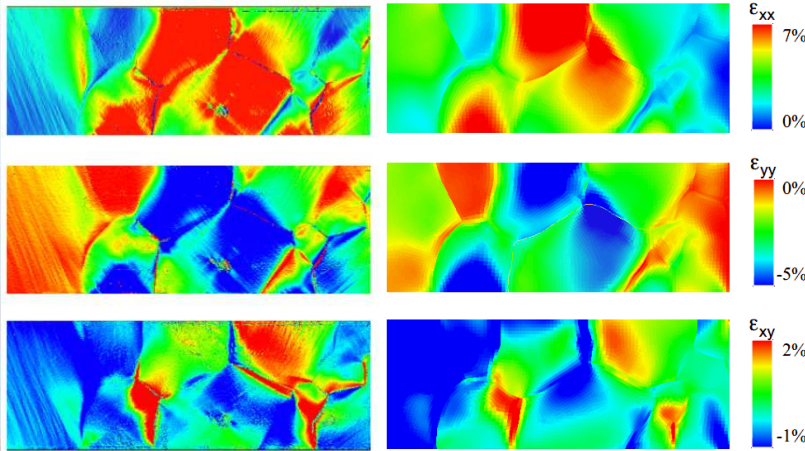


*Ta single crystal  
[100] orientation*

*Ta polycrystal  
482 grains*

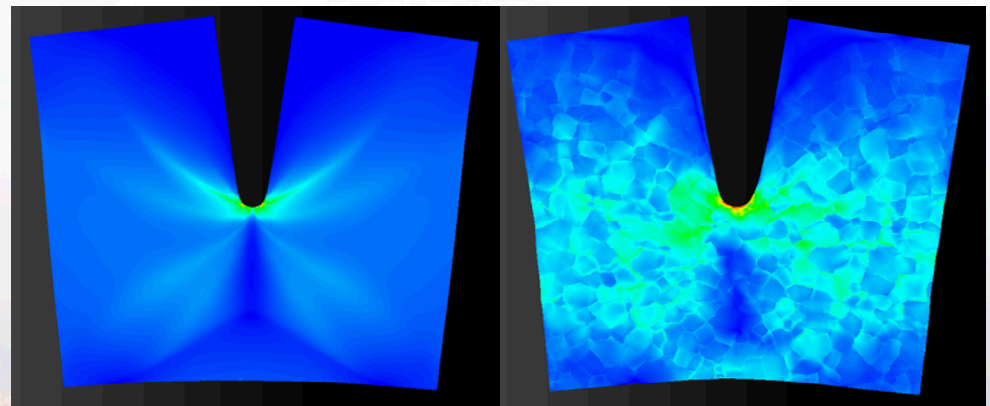


*Oligocrystal experiments vs. crystal plasticity  
models (tensile loading)*



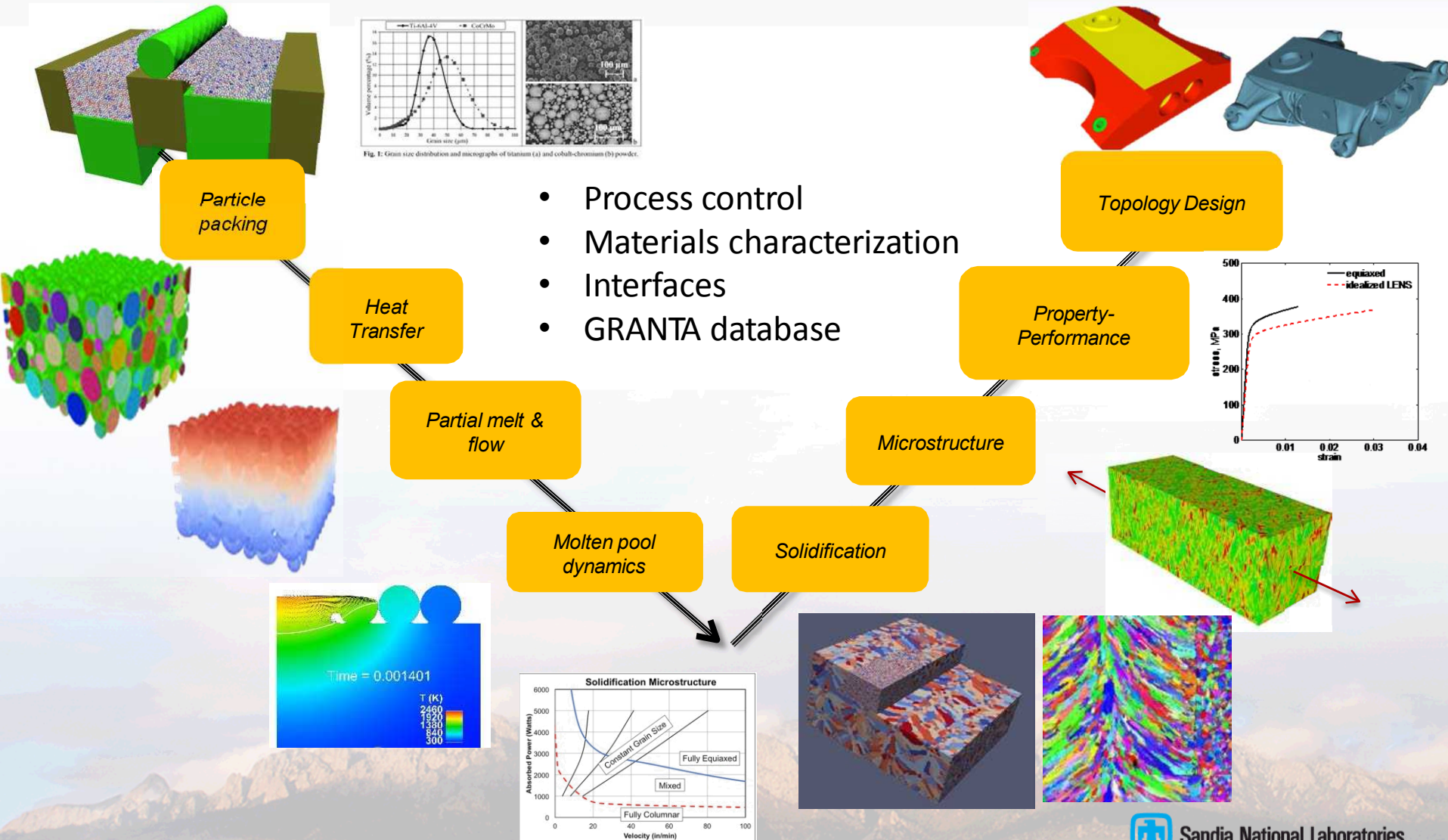
*Experimental Results*

*Simulations*



*(a) Von Mises stress distributions:  
single crystal vs. polycrystal*

*Ultimate Vision is to Understand/Control  
Process → Microstructure → Properties → Performance*





# Multi-Material AM



# Sandia has Strong Capabilities/Expertise In Printed Electronics

Printed Encapsulant

Current Collector

Printable Separator

Printed Anode / Cathode

## Printed flexible battery

Encapsulant (DW UV-curable epoxy)

Current collector (DW carbon ink)

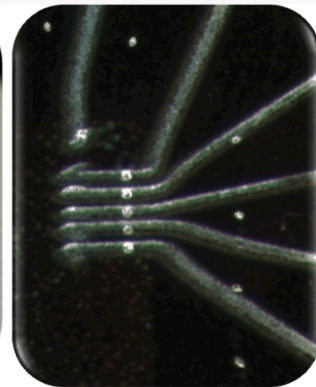
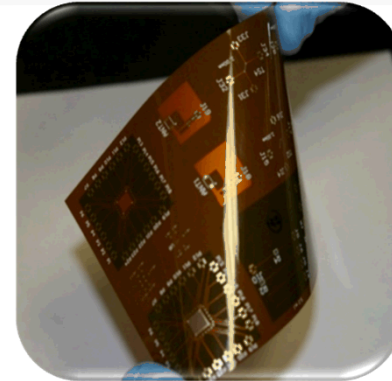
Anode (DW graphite/carbon)

Separator (DW mesoporous polymers)

Cathode (DW  $\text{LiFePO}_4$ )

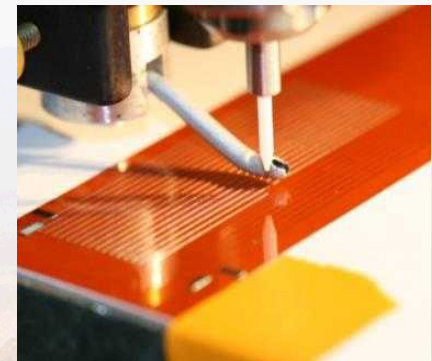
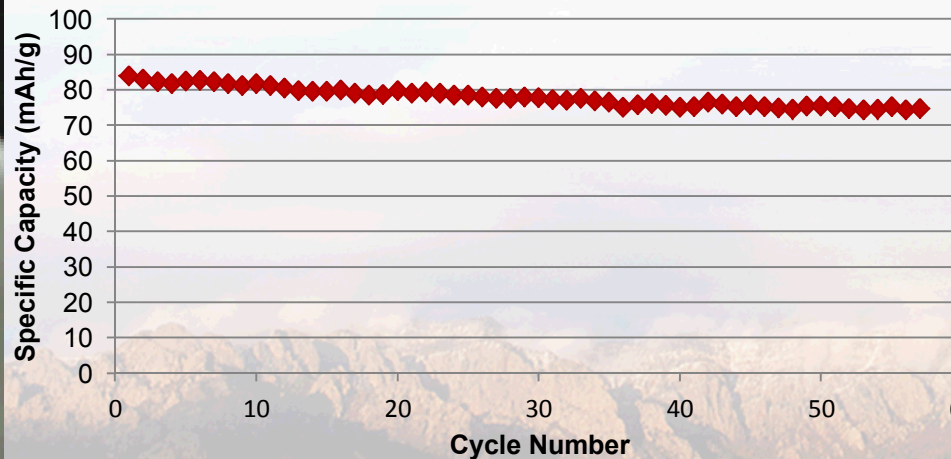
Current collector (DW copper ink)

Substrate (polyimide)



“Flexible Chips” with  
printed wirebonds

## $\text{LiFePO}_4$ Battery performs well in repeated cycling



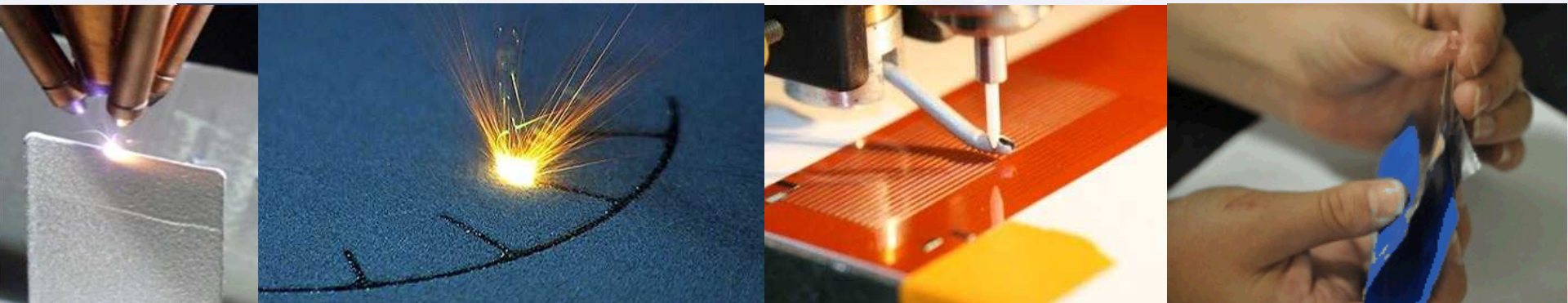
Aerosol jet printing to 10  $\mu\text{m}$



Sandia National Laboratories

# Summary

- Sandia has a rich history in AM technology development & commercialization
- Special interest in Design for AM, Materials Assurance, & Multi-Material AM
- Strong, uncommon, experimental and computational capabilities
- Strong interest in teaming with universities in areas of mutual interest



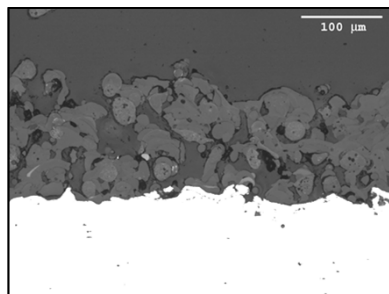


# Backup Slides

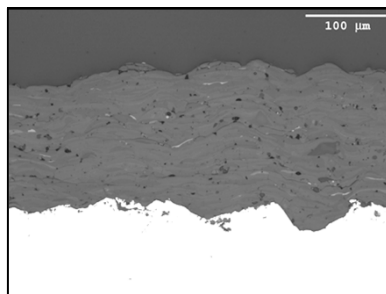


# Fundamental Process Understanding is Key to Controlling Variability

Same System, Same Feedstock,

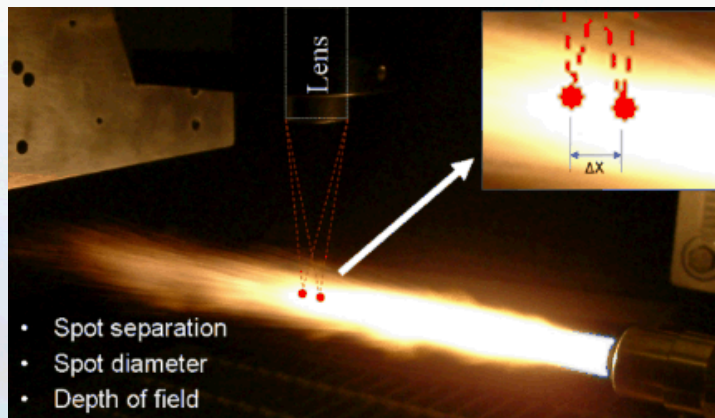


VS.



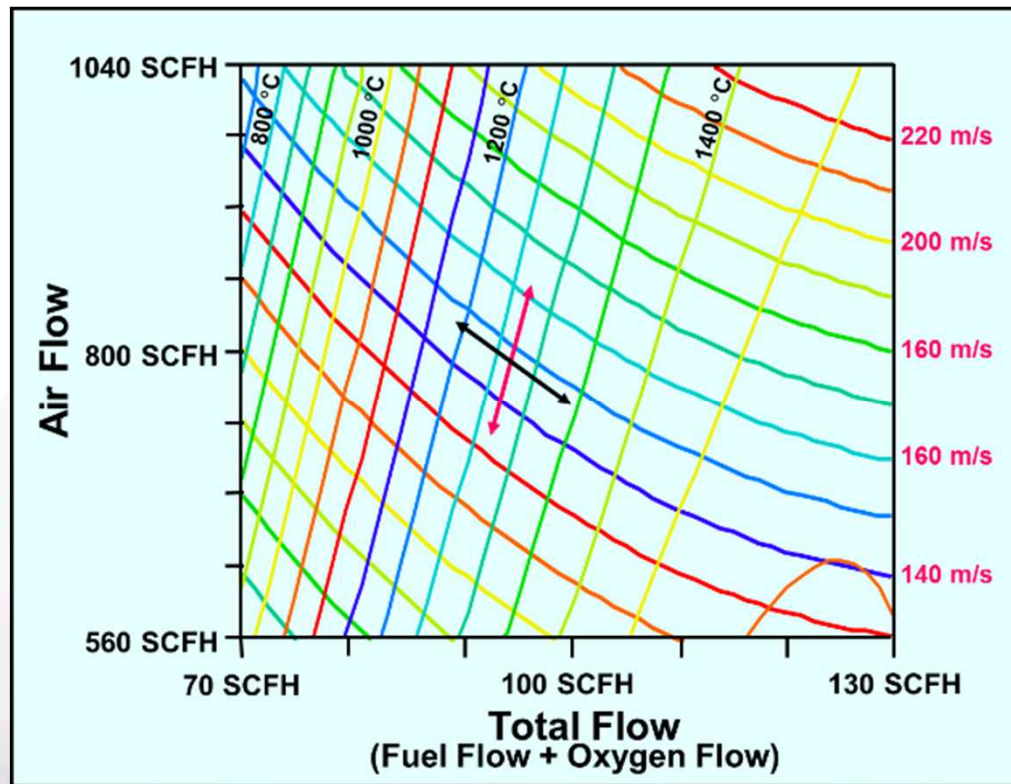
Very Different Results!

- Experimental/computational R&D used to develop processing-microstructure-properties relationships



Process Diagnostics/Monitoring

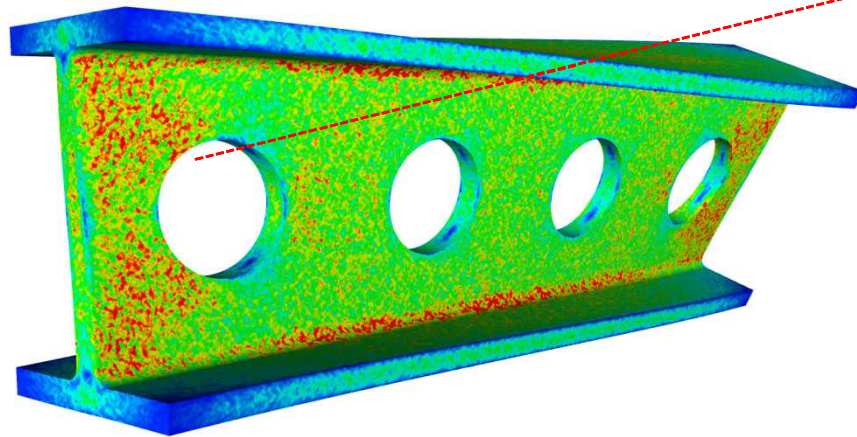
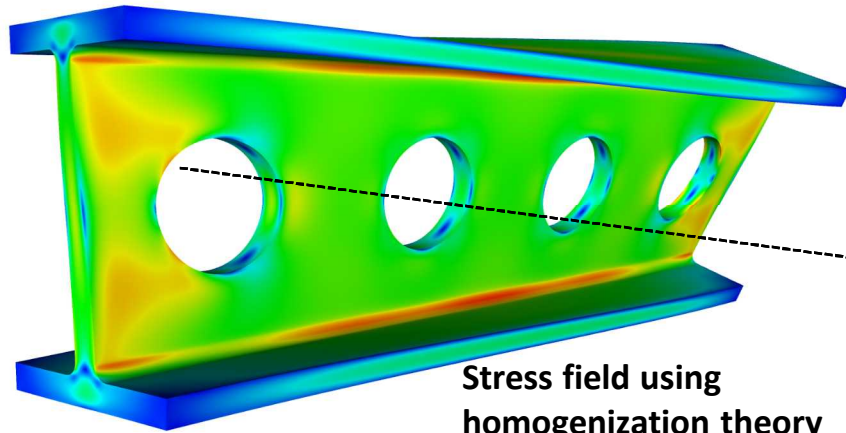
Fundamental process understanding enables closed-loop control based on droplet temperature and velocity to reduce variability



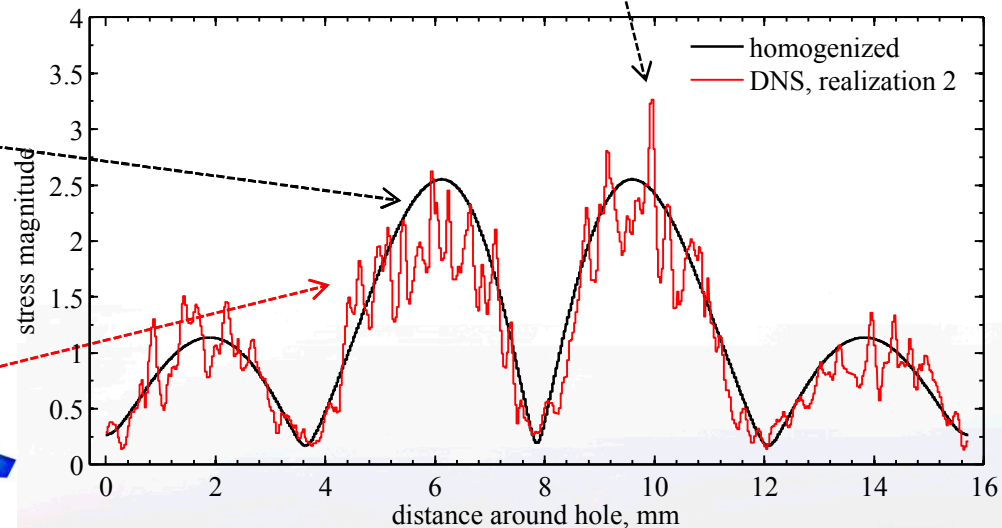
Response surface showing relationships between Process Inputs (Air Flow, Fuel Flow, Oxygen Flow) and Critical Outputs (droplet temperature, droplet velocity)

# Microstructure Influences Variability & Failure

Homogenization theory misses local details - potential fracture initiation



**“Enriched physics”**



- Homogenization filters physics necessary to predict failure
- Microstructure influences peak stress

Stress field using Direct Numerical Simulation

J. E. Bishop